

# 1:3 and 1:4 Single-Ended, Low Cost, Active RF Splitters

# ADA4304-3/ADA4304-4

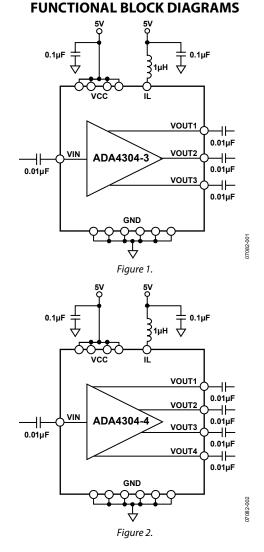
#### **FEATURES**

Ideal for CATV and terrestrial applications 2.4 GHz, -3 dB bandwidth 1 dB flatness: 54 MHz to 865 MHz Low noise figure: 4.6 dB Low distortion Composite second-order (CSO): -62 dBc Composite triple beat (CTB): -72 dBc Nominal 3 dB gain per output channel 25 dB output-to-output isolation, 50 MHz to 1000 MHz 75 Ω input and outputs Small package size: 16-lead, 3 mm × 3 mm LFCSP

#### APPLICATIONS

Set-top boxes Residential gateways CATV distribution systems Splitter modules Digital cable ready (DCR) TVs

### \_\_\_\_\_



#### **GENERAL DESCRIPTION**

The ADA4304-3/ADA4304-4 are 75  $\Omega$  active splitters for use in applications where a lossless signal split is required. Typical applications include multituner digital set-top boxes, cable splitter modules, multituners/digital cable ready (DCR) televisions, and home gateways where traditional solutions require discrete passive splitter modules with separate fixed gain amplifiers.

The ADA4304-3/ADA4304-4 are fabricated using the Analog Devices, Inc., proprietary silicon germanium (SiGe), complementary bipolar process, enabling them to achieve very low levels of distortion with a noise figure of 4.6 dB. The parts provide low cost alternatives that simplify designs and improve system performance by integrating a signal splitter element and a gain block into a single IC. The ADA4304-3/ADA4304-4 are available in a 16-lead LFCSP and operate in the extended industrial temperature range of  $-40^{\circ}$ C to  $+85^{\circ}$ C.

Rev. 0

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

## TABLE OF CONTENTS

Features
Applications1
Functional Block Diagrams 1
General Description
Revision History
Specifications
Absolute Maximum Ratings 4
Thermal Resistance 4
ESD Caution 4
Pin Configurations and Function Descriptions

Typical Performance Characteristics
Test Circuits
Applications
Circuit Description
Evaluation Boards
RF Layout Considerations10
Power Supply10
Outline Dimensions
Ordering Guide 12

#### **REVISION HISTORY**

11/07—Revision 0: Initial Version

### **SPECIFICATIONS**

 $V_{\text{CC}}$  = 5 V, 75  $\Omega$  system,  $T_{\text{A}}$  = 25°C, unless otherwise noted.

#### Table 1.

			ADA4304-3			ADA4304-4		
Parameter	Conditions	Min	Тур	Max	Min	Тур	Max	Unit
DYNAMIC PERFORMANCE	See Figure 19 for test circuit							
Bandwidth (–3 dB)			2400			2400		MHz
Frequency Range		54		865	54		865	MHz
Gain	f = 100 MHz		3.3			2.9		dB
Gain Flatness	54 MHz to 865 MHz		1.0			1.0		dB
NOISE/DISTORTION PERFORMANCE								
Noise Figure <sup>1</sup>	@ 54 MHz		4.0			4.0		dB
	@ 550 MHz		4.6			4.6		dB
	@ 865 MHz		4.8			4.8		dB
Output IP3	$f_1 = 97.25 \text{ MHz}, f_2 = 103.25 \text{ MHz}$		26			26		dBm
Output IP2	$f_1 = 97.25 \text{ MHz}, f_2 = 103.25 \text{ MHz}$		43			43		dBm
Composite Triple Beat (CTB)	135 channels, 15 dBmV/channel, f = 865 MHz		-72			-72		dBc
Composite Second Order (CSO)	135 channels, 15 dBmV/channel, f = 865 MHz		-62			-62		dBc
Cross Modulation (CXM)	135 channels, 15 dBmV/channel, 100% modulation @ 15.75 kHz, f = 865 MHz		-68			-68		dBc
INPUT CHARACTERISTICS	See Figure 19 for test circuit							
Input Return Loss	@ 54 MHz		-17	-13		-18	-14	dB
	@ 550 MHz		-22	-16		-21	-15	dB
	@ 865 MHz		-12	-8		-12	-8	dB
Output-to-Input Isolation	Any output, 54 MHz to 865 MHz							
	@ 54 MHz		-33	-30		-33	-31	dB
	@ 550 MHz		-33	-30		-33	-31	dB
	@ 865 MHz		-34	-31		-35	-32	dB
OUTPUT CHARACTERISTICS	See Figure 19 and Figure 20 for test circuits							
Output Return Loss	Any output, 54 MHz to 865 MHz							
	@ 54 MHz		-21	-17		-21	-17	dB
	@ 550 MHz		-16	-11		-17	-12	dB
	@ 865 MHz		-14	-9		-14	-9	dB
Output-to-Output Isolation	Any output, 54 MHz to 865 MHz							dB
	@ 54 MHz		-26			-26		dB
	@ 550 MHz		-25			-25		dB
	@ 865 MHz		-25			-25		dB
1 dB Compression (P1dB)	Output referred, f = 100 MHz		9.0			8.7		dBm
POWER SUPPLY								
Nominal Supply Voltage		4.75	5.0	5.25	4.75	5.0	5.25	V
Quiescent Supply Current			92	105		92	105	mA

 $^{\scriptscriptstyle 1}$  Characterized with 50  $\Omega$  noise figure analyzer.

### **ABSOLUTE MAXIMUM RATINGS**

#### Table 2.

Tuble II	
Parameter	Rating
Supply Voltage	5.5 V
Power Dissipation	See Figure 3
Storage Temperature Range	–65°C to +125°C
Operating Temperature Range	-40°C to +85°C
Lead Temperature (Soldering, 10 sec)	300°C
Junction Temperature	150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### THERMAL RESISTANCE

 $\theta_{JA}$  is specified for the device (including exposed pad) soldered to a high thermal conductivity 4-layer (2s2p) circuit board, as described in EIA/JESD 51-7.

#### Table 3. Thermal Resistance

Package Type	Αιθ	Unit
16-Lead LFCSP (Exposed Pad)	98	°C/W

#### Maximum Power Dissipation

The maximum safe power dissipation in the ADA4304-3/ ADA4304-4 package is limited by the associated rise in junction temperature (T<sub>I</sub>) on the die. At approximately 150°C, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance. Exceeding a junction temperature of 150°C for an extended period can result in changes in the silicon devices, potentially causing failure. The power dissipated in the package  $(P_D)$  is essentially equal to the quiescent power dissipation, that is, the supply voltage  $(V_S)$ times the quiescent current  $(I_S)$ . In Table 1, the maximum power dissipation of the ADA4304-3/ADA4304-4 can be calculated as

 $P_{D(MAX)} = 5.25 \text{ V} \times 105 \text{ mA} = 551 \text{ mW}$ 

Airflow increases heat dissipation, effectively reducing  $\theta_{JA}$ . In addition, more metal directly in contact with the package leads/exposed pad from metal traces, through-holes, ground, and power planes reduces the  $\theta_{JA}$ .

Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 16-lead LFCSP (98°C/W) on a JEDEC standard 4-layer board.

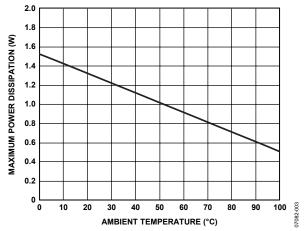


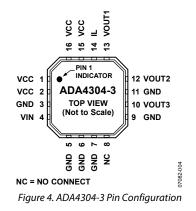
Figure 3. Maximum Power Dissipation vs. Temperature for a 4-Layer Board

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

# **PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS**



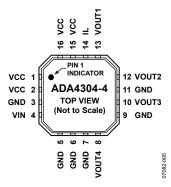
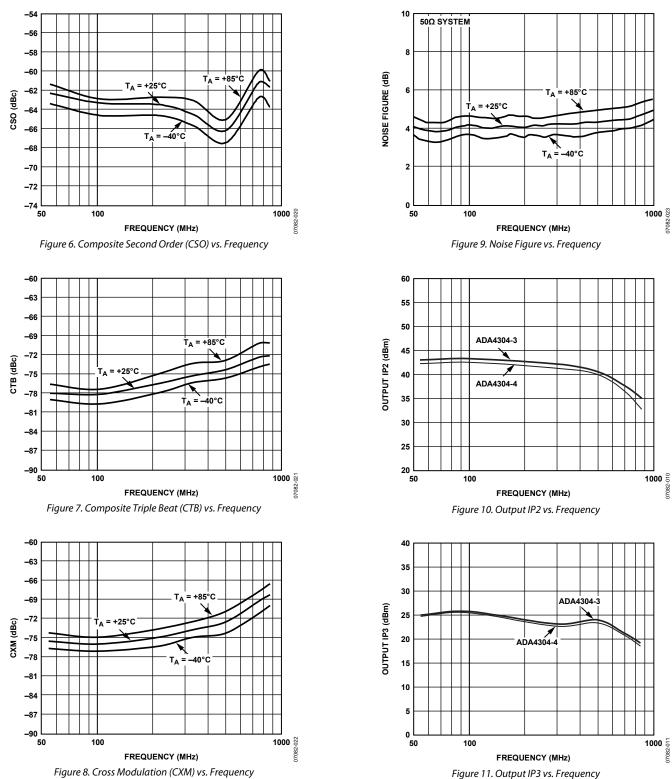


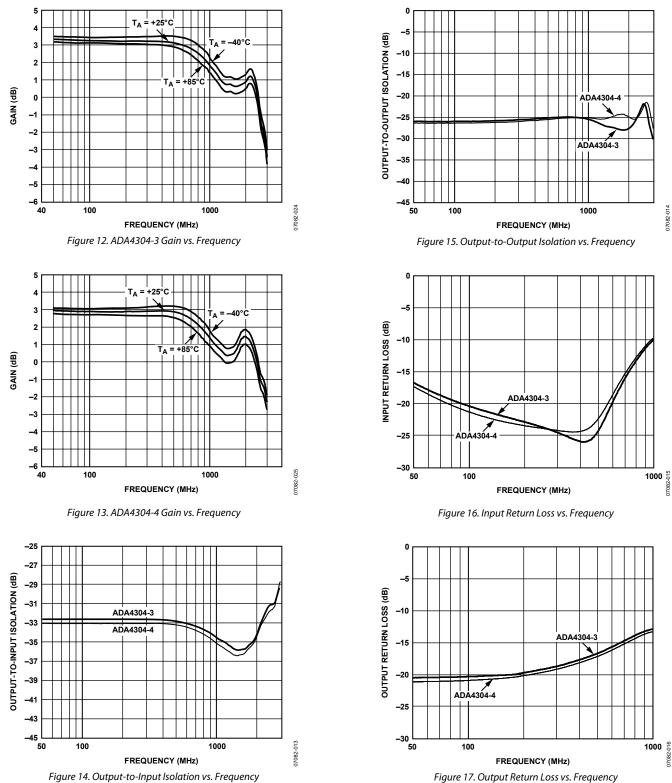
Figure 5. ADA4304-4 Pin Configuration

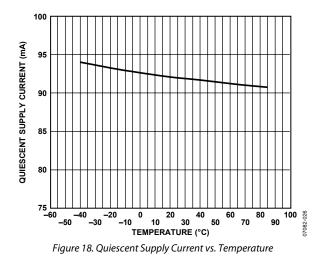
Pin No.	Mnemonic	Description	Pin No.	Mnemonic	Description
1, 2, 15, 16	VCC	Supply Pin.	1, 2, 15, 16	VCC	Supply Pin.
3, 5 to 7, 9, 11	GND	Ground.	3, 5 to 7, 9, 11	GND	Ground.
4	VIN	Input.	4	VIN	Input.
8	NC	No Connection.	8	VOUT4	Output 4.
10	VOUT3	Output 3.	10	VOUT3	Output 3.
12	VOUT2	Output 2.	12	VOUT2	Output 2.
13	VOUT1	Output 1.	13	VOUT1	Output 1.
14	IL	Bias Pin.	14	IL	Bias Pin.

# **TYPICAL PERFORMANCE CHARACTERISTICS**

 $V_{\text{CC}}$  = 5 V, 75  $\Omega$  system,  $T_{\text{A}}$  = 25°C, unless otherwise noted.







# **TEST CIRCUITS**

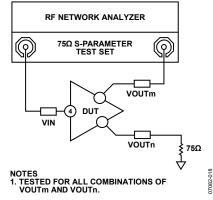


Figure 19. Test Circuit for Transmission, Isolation, and Reflection Measurements

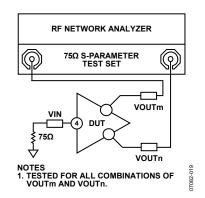


Figure 20. Test Circuit for Output-to-Output Isolation Measurements

### **APPLICATIONS**

The ADA4304-3/ADA4304-4 active splitters are primarily intended for use in the downstream path of television set-top boxes (STBs) that contain multiple tuners. They are typically located directly after the diplexer in a bidirectional CATV customer premise unit. The ADA4304-3/ADA4304-4 provide a single-ended input and three or four single-ended outputs that allow the delivery of the RF signal to multiple signal paths. These paths can include, but are not limited to, a main picture tuner, the picture-in-picture (PIP) tuner, an out-of-band (OOB) tuner, a digital video recorder (DVR), and a cable modem (CM).

The ADA4304-3/ADA4304-4 exhibit composite second-order (CSO) and composite triple beat (CTB) products that are –62 dBc and –72 dBc, respectively. The use of the SiGe bipolar process also allows the ADA4304-3/ADA4304-4 to achieve a noise figure (NF) of 4.6 dB at 550 MHz.

### **CIRCUIT DESCRIPTION**

The ADA4304-3/ADA4304-4 consist of a low noise buffer amplifier followed by a resistive power divider. This arrangement provides 3.3 dB (ADA4304-3) or 2.9 dB (ADA4304-4) of gain relative to the RF signal present at the input of the device. The input and each output must be properly matched to a 75  $\Omega$  environment for distortion and noise performance to match the data sheet specifications. AC coupling capacitors of 0.01  $\mu F$  are recommended for the input and outputs.

A 1  $\mu$ H RF choke (Coilcraft chip inductor 0805LS-102X) is required to correctly bias the internal nodes of the ADA4304-3/ ADA4304-4. It should be connected between the 5 V supply and the IL pin (Pin 14). The choke should be placed as close as possible to the ADA4304-3/ADA4304-4 to minimize parasitic capacitance on the IL pin, which is critical for achieving the specified bandwidth and flatness.

### **EVALUATION BOARDS**

The ADA4304-3/ADA4304-4 evaluation board allows designers to assess the performance of the parts in their particular application. The board includes 75  $\Omega$  coaxial connectors and 75  $\Omega$  controlled-impedance signal traces that carry the input and output signals. Power (5 V) is applied to the red VCC loop connector, and ground is connected to the black GND loop connector. Figure 21 is a schematic of the evaluation board. On the ADA4304-3 evaluation board, connector VO4 and C7 are not populated.

#### **RF LAYOUT CONSIDERATIONS**

Appropriate impedance matching techniques are mandatory when designing circuit boards for the ADA4304-3/ADA4304-4. Improper characteristic impedances on traces can cause reflections that can lead to poor linearity. The characteristic impedance of the signal trace to the input and from each output should be 75  $\Omega$ . Any ground metal on the top surface near signal lines should be stitched with vias to the internal ground plane, as shown in Figure 22. The device package exposed paddle must be reflow soldered to a low inductance ground to achieve data sheet performance specifications. This is achieved by connecting the footprint ground pad with vias to a ground plane below (see Figure 22).

### **POWER SUPPLY**

The 5 V supply should be applied to each VCC pin and RF choke via a low impedance power bus. The power bus should be decoupled to ground using a 10  $\mu$ F tantalum capacitor and a 0.1  $\mu$ F ceramic chip capacitor located close to the ADA4304-3/ ADA4304-4. In addition, the VCC pins should be decoupled to ground with a 0.1  $\mu$ F ceramic chip capacitor located as close to each pin as possible.

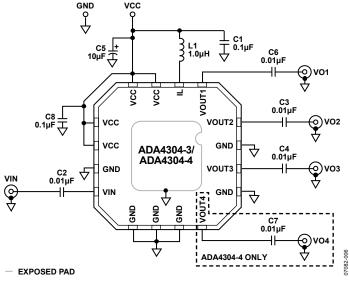
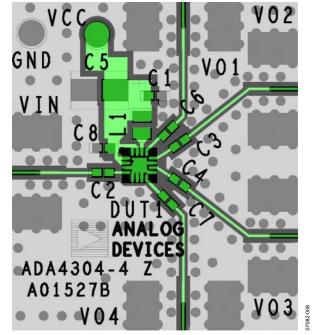


Figure 21. Evaluation Board Schematic



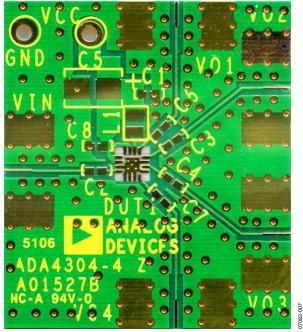
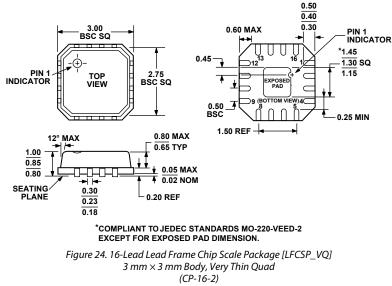


Figure 22. Evaluation Board

Figure 23. Evaluation Board Component Layout

### **OUTLINE DIMENSIONS**



Dimensions shown in millimeters

#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option	Ordering Quantity	Branding
ADA4304-3ACPZ-RL <sup>1</sup>	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	5,000	H16
ADA4304-3ACPZ-R71	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	1,500	H16
ADA4304-3ACPZ-R2 <sup>1</sup>	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	250	H16
ADA4304-4ACPZ-RL <sup>1</sup>	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	5,000	H10
ADA4304-4ACPZ-R7 <sup>1</sup>	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	1,500	H10
ADA4304-4ACPZ-R2 <sup>1</sup>	-40°C to +85°C	16-Lead LFCSP_VQ	CP-16-2	250	H10

 $^{1}$  Z = RoHS Compliant Part.



www.analog.com